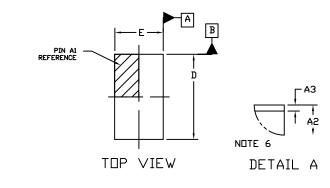
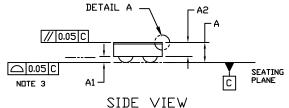
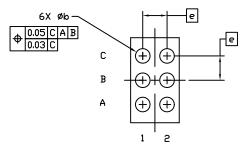
WLCSP6 1.4x0.8x0.37 CASE 567YU ISSUE O

DATE 14 NOV 2019







BOTTOM VIEW

GENERIC MARKING DIAGRAM*



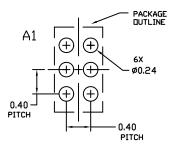
XX = Specific Device Code M = Month Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 5. DIMENSION 6 IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER PARALLEL TO DATUM C.
- 6. BACKSIDE COATING IS OPTIONAL.

| | MILLIMETERS | | |
|-----|-------------|-------|-------|
| DIM | MIN. | N□M. | MAX. |
| Α | | 0.330 | 0.370 |
| A1 | 0.080 | 0.100 | 0.120 |
| A2 | 0.230 REF | | |
| A3 | 0.020 | 0.025 | 0.030 |
| b | 0.220 | 0.240 | 0.260 |
| D | 1.370 | 1.400 | 1.430 |
| Ε | 0.770 | 0.800 | 0.830 |
| e | 0.400 BSC | | |



RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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|------------------|---------------------|---|-------------|--|
| DESCRIPTION: | WLCSP6 1.4x0.8x0.37 | | PAGE 1 OF 1 | |

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